



PCB LAYOUT
COMPONENT SIDE SHOWN

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN. @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.
6. OPERATING: 750 CYCLES MIN.

MECHANICAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER OR HIGH TEMP. UL94V-0 BK.
2. INSERT MATERIAL : GLASS FILLED POLYESTER UL94V-0 BK.
3. CONTACT MATERIAL : PHOSPHOR BRONZE 0.35mm THICKNESS.
4. PLATING : XXu" GOLD PLATING OVER NICKEL.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
2. OPERATION: -40°C TO +85°C.
3. WAVE SOLDERING TEMPERATURE: 255~265°C (5~10 SECONDS)

RoHS Compliant		HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准		TOLERANCE 容許公差	PART NAME 品名
DWG. 製圖	<i>Helen</i>	0 ± 0.35 .00 ± 0.25 ANG. ± 5°	LED JACK 8P8C UNSHIELDED WITHOUT LED FLAT PIN BLACK INSULATOR ROHS
DATE 制表日	UNIT 單位	SIZE 紙張尺寸	PART NO.
2021/1/29	M M	A 4	料號 C0073-AANXB001R
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